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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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of

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	Complete if Known				
	Application Number	10/642,305			
	Filing Date	08/18/2003			
	First Named Inventor	Hongyong ZHANG et al.			
	Art Unit	2811			
	Examiner Name	Douglas Owens			
	Attorney Docket Number	740756-2646			

	U.S. PATENT DOCUMENTS						
Examiner Initials	Cite No.1	U.S. Patern Document	Publication Date	Name of Patentee or	Pages, Cohumns, Lines, Where		
		Number - Kind Code ² (if known)		Applicant of Cited Document	Relevant Passages or Relevant Figures Appear		
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Examiner Initials	Cite No.'	Foreign Patent Document	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant	T ⁴
		Country Code ³ Number ⁴ (If Intown)	MM-DD-YYYY	Application of Cited Document	Figures Appear	
DWO	JP 62-104117 A		05/14/1987	YUKI		FULL
		OTHER PRIOR A	ART NON PATENT I	ITERATURE DOCUMENTS		
Examiner Initials				T²		
						
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Examiner Signature	/Douglas W Owens/	Date Considered 07/10/2006

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¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

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DWO		JP 01-268064 A	10/25/1989	Hashimoto et al.		FULL
DWO JP 60-105216 06/10/1985 Shimizu et al.		Shimizu et al.		FULL		
		OTHER PRIOR	ART – NON PATENT I	LITERATURE DOCUMENTS		
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.)., date, page(s), volume-issue number(s), publisher, city and/or country where published.				T ²
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DWO		Ohwada, et al., "Peripheral Circuit Integrated Poly-Si TFT LCD with Gray Scale Representation", IEEE Transactions on Electron Devices, Vol. 36, No. 9, pp. 1923-1928 (Sept. 1989)				
DWO	DWO Masumo et al., "Low Temperature Fabrication of Poly-Si TFT by Laser Induced Crystallization of a-Si," <u>Journal of Non-Crystalline Solids</u> , Vol. 115, pp. 147-149 (1989)					
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				Examiner Name	Douglas Owens
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		OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS					
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DWC		Wright et al., "Hot-Electron Immunity of SiO ₂ Dielectrics with Fluorine Incorporation", IEEE Electron Device Letters, Vol. 10, No. 8, pp. 347-348 (Aug. 1989)					
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		Aritome et al., "Low-temperature nitridation of fluorinated silicon dioxide films in ammonia gas", Applied Physics Letters, Vol. 51, No. 13, pp. 981-983 (Sept. 28, 1987) Zaima et al., "Effects of fluorine ion implantation on metal-oxide-semiconductor devices of silicon-on-sapphire", Applied Physics Letters, Vol. 52, No. 6, pp. 459-461 (Feb. 8, 1988)					
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	V	Liu et al., "Raman Characterisation of stress in Recrystallised Silicon-On Insulator", Electronics Letters, Vol. 24, No. 23, pp. 1420-1422 (Nov. 10, 1988)					
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	DWO	Takenaka et al., "High Mobility Poly-Si Thin Film Transistors Using Solid Phase Crystallized a-Si Films Deposited by Plasma-Enhanced Chemical Vapor Deposition, Japanese J. of Applied Physics, Vol. 29, No. 12, pp. L2380-L2383(Dec. 1990)	
	DWO	Sameshima et al., "XeCl Excimer Laser Annealing Used to Fabricate Poly-Si TFT's", Japanese J. of Applied Physics, Vol. 28, No. 10, pp. 1789-1793 (Oct. 1989)	
	DWO	Madan et al., "Use of PECVD System in Thin Film Technology", Workshop on Industrial Plasma Applications, pp. 1-11 (Sept. 1989)	
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	DWO	Sameshima et al., "XeCl Excimer Annealing Used in the Fabrication of Poly-Si TFT's", IEEE Electron Device Letters, Vol. EDL-7, No. 5, pp. 276-278 (May 1986)	
	DWC	Sera et al., "High Performance TFT's Fabricated by XeCl Excimer Laser Annealing of Hydrogenated Amorphous-Silicon Film, <u>IEEE Transactions on Electron Devices</u> , Vol. 36, No. 12, pp. 2868-2872 (Dec. 1989)	
	DWO	S. Wolf & R.N. Tauber, Silicon Processing for the VLSI Era-Process Technology, pp. 164-175 (1986)	
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